# 503688771 02/11/2016

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
PO-CHENG SHIH	04/19/2012
YU-YUN PENG	04/19/2012
CHIA-CHENG CHOU	04/19/2012
JOUNG-WEI LIOU	04/24/2012

## **RECEIVING PARTY DATA**

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.	
Street Address:	NO. 8, LI-HSIN RD. 6	
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK	
City:	HSIN-CHU	
State/Country:	TAIWAN	
Postal Code:	300-77	

# **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15018661

#### **CORRESPONDENCE DATA**

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NAME OF SUBMITTER:	JANIE MARTINEZ-HOLM	
SIGNATURE:	/Janie Martinez-Holm/	
DATE SIGNED:	02/11/2016	

**Total Attachments: 1** 

PATENT REEL: 037717 FRAME: 0108

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PATENT REEL: 037717 FRAME: 0109

Docket No. T5057-743 TSMC2011-1631

# ASSIGNMENT

In consideration of the premises and other	good and valuable consideration	in hand paid,	the receipt and	sufficiency of
which is hereby acknowledged, the undersigned,		• ,	•	

1) Po-Cheng SHIH

4) Joung-Wei LIOU

- 2) Yu-Yun PENG
- 3) Chia Cheng CHOU

who has made a certain new and useful invention, hereby sells, assigns and transfers unto

# TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD. having a place of business at No.

# 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu 300, Taiwan R.O.C.

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

## INTERCONNECT STRUCTURE AND METHOD FOR FORMING THE SAME

(a)	for which an application for United States Letters Patent was filed on 2012-04-30,	and	identified	bу	United
	States Patent Application No. 13/460, 279; or				

(b)	for which an application for United States Letters Patent was executed on
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and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

1) Po Chang Shih	2012. Apr. 19th
Name: Po-Cheng SHIH	Date:
2) ymplat	2012, Apr. 19th
Name: Yu-Yun PENG (	Date:
3) Chra-Geng CHOU	>0/2, Apr. 9th
Name: Chia Cheng CHOU	Date:
4) J. W. Lon.	2012 4. 24
Name: Joung Wai LIOTI	Doto:

PATENT REEL: 037717 FRAME: 0110

RECORDED: 02/11/2016